High Voltage LED Series Chip on Board

LCo₁₃D – Gen.₁



High efficacy COB LED package well-suited for use in spotlight applications









Features & Benefits

- Chip on Board (COB) solution makes it easy to design in
- · Simple assembly reduces manufacturing cost
- · Low thermal resistance
- InGaN/GaN MQW LED with long time reliability

Applications

- Spotlight / Downlight
- LED Retrofit Bulbs
- Outdoor Illumination

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1. Characteristics

a) Absolute Maximum Rating

ltem	Symbol	Rating	Unit	Condition
Ambient / Operating Temperature	Ta	-40 ~ +105	°C	-
Storage Temperature	T_{stg}	-40 ~ +120	°C	-
LED Junction Temperature	TJ	140	°C	-
Case Temperature	Tc	105	°C	
Forward Current	l _F	920	mA	-
Power Dissipation	P _D	34.5	W	-
ESD (HBM)	-	±2	kV	-
ESD (MM)	-	±0.5	kV	-

b) Electro-optical Characteristics ($I_F = 360 \text{ mA}, T_J = 85 \text{ }^{\circ}\text{C}$)

ltem	Unit	Rank	Min.	Тур.	Max.
Forward Voltage (V _F)	V	YZ	31.8	34.6	37.5
Color Rendering Index (R.)		5	80	-	-
Color Rendering Index (R _a)	-	7	90		
Thermal Resistance (junction to chip point)	°C/W		-	1.4	-
Beam Angle	0		-	115	-
Nominal Power	W			13.5	

Notes:

- 1) The COB is tested in pulsed condition at rated test current (10 ms pulse width) and rated temperature ($T_J = T_C = T_a = 85$ °C)
- 2) Samsung maintains measurement tolerance of: forward voltage = ± 5 %, CRI = ± 1
- 3) Refer to the derating curve, '3. Typical Characteristics Graph' designed within the range.

c) Luminous Flux Characteristics (I_F = 360 mA)

CRI (R _a)	Nominal	Nominal Flux		Flux @ T _J = 85 °C (lm)			
Min.	CCT (K)	Rank	Min.	Тур.	Max.		
	2700	H5	1510	1589	-		
	2700	D1	1589	1669	-		
	3000	H5	1589	1673	-		
	3000	D1	1673	1757	-		
	3500	H6	1639	1725	-		
	3300	D1	1725	1812	-		
80	4000	H6	1669	1757	-		
60	4000	D1	1757	1844	-		
	5000	H6	1684	1772	-		
	3000	D1	1772	1861	-		
	F700	H6	1684	1772	-		
	5700	D1	1772	1861	-		
	6500	H6	1659	1746	-		
	6500	D1	1746	1834	-		

CRI (R _a)	Nominal	Flux	Flux @ T _J = 85 °C (lm)			
Min.	CCT (K)	Rank	Min.	Тур.	Max.	
	2700	H2	1291	1359	-	
	2700	D1	1359	1427	-	
	3000	НЗ	1352	1423	-	
	3000	D1	1423	1494	-	
90	3500	H4	1400	1473	-	
90		D1	1473	1547	-	
	4000	H4	1429	1505	-	
	4000	D1	1505	1580	-	
	5000	H4	1433	1508	-	
	5000	D1	1508	1584	-	

Notes:

- 1) The COB is tested in pulsed operating condition at rated test current (10 ms pulse width) and rated temperature $(T_J = T_C = 85 \, ^{\circ}C)$.
- 2) Samsung maintains measurement tolerance of: Luminous flux = ± 7 %, CRI = ± 1

2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
s	Р	н	W	н	Α	н	D	N	D	2	5	Υ	z	W	3	н	5

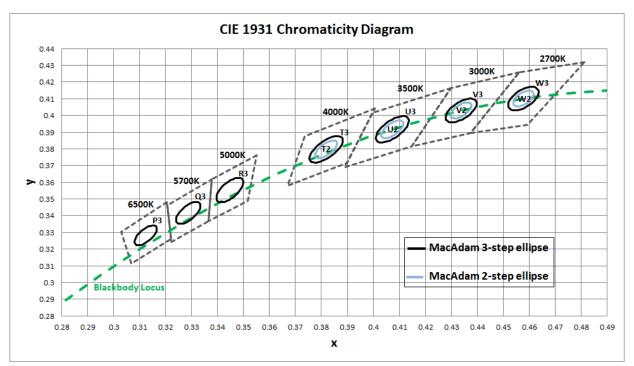
Digit	PKG Information	Code	Specification
1 2 3	Samsung Package High Power	SPH	
4 5	Color	WH	White
6	Product Version	Α	
7 8	Form Factor	HD	СОВ
9	Lens Type	N	No lens
10	Wattage or Model	D	LC013D
11	Internal Code	2	
12	CRI & Sorting Temperature	5	Min. 80 (85°C)
12		7	Min. 90 (85°C)
13 14	Forward Voltage (V)	YZ	31.8~37.5
15	CCT (K)	W V U T R Q	2700K 3000K 3500K 4000K 5000K 5700K 6500K
16	MacAdam Step	3	MacAdam 2-step MacAdam 3-step
17 18	Luminous Flux (Lm)	H2 H3 H4 H5 H6 D1	Min. 1200 Min. 1300 Min. 1400 Min. 1500 Min. 1600 Add rank

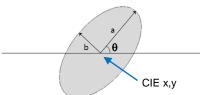
a) Binning Structure (I_F = 360 mA, T_J = 85 °C)

CRI (R _a) Min.	Nominal CCT (K)	Product Code	V _F Rank	Color Rank	Flux Rank	Flux Range (Φ _v , lm)
		SPHWHAHDND25YZW2H5		W2		
		SPHWHAHDND25YZW3H5		W3	- H5	1510 ~
	2700	SPHWHAHDND25YZW2D1	YZ	W2		
	<u></u>	SPHWHAHDND25YZW3D1		W3	- D1	1589 ~
		SPHWHAHDND25YZV2H5		V2	H5	4-00
		SPHWHAHDND25YZV3H5	V7	V3		1589 ~
	3000	SPHWHAHDND25YZV2D1	YZ	V2		4070
		SPHWHAHDND25YZV3D1		V3	• D1	1673 ~
		SPHWHAHDND25YZU2H6		U2	LIO	4000
		SPHWHAHDND25YZU3H6		U3	H6	1639 ~
	3500	SPHWHAHDND25YZU2D1	YZ	U2	5.4	4705
80		SPHWHAHDND25YZU3D1		U3	· D1	1725 ~
		SPHWHAHDND25YZT2H6		T2	H6	4000
	4000	SPHWHAHDND25YZT3H6	YZ	Т3	по	1669 ~
	4000	SPHWHAHDND25YZT2D1	····· YZ	T2	D1	1757 ~
	••••	SPHWHAHDND25YZT3D1		Т3	. Бі	1757 ~
	5000	SPHWHAHDND25YZR3H6	······ YZ	R3	H6	1684 ~
	3000	SPHWHAHDND25YZR3D1	12	KS	D1	1772 ~
	6700	SPHWHAHDND25YZQ3H6	V7	O3	Н6	1684 ~
	3700	5700 YZ Q3 SPHWHAHDND25YZQ3D1 D1		D1	1772 ~	
	GEOO	SPHWHAHDND25YZP3H6		Do	H6	1659 ~
	6500	SPHWHAHDND25YZP3D1	····· YZ	P3	D1	1746 ~

CRI (R _a) Min.	Nominal CCT (K)	Product Code	V _F Rank	Color Rank	Flux Rank	Flux Range (Φ _v , lm)
		SPHWHAHDND27YZW2H2		W2	H2	1291 ~
	2700	SPHWHAHDND27YZW3H2	YZ	W3	П	1291 ~
	2700	SPHWHAHDND27YZW2D1	12	W2	D1	1359 ~
		SPHWHAHDND27YZW3D2		W3	DI	1359 ~
		SPHWHAHDND27YZV2H3		V2	Н3	1352 ~
	3000	SPHWHAHDND27YZV3H3	YZ	V3	ПЭ	1332 ~
	3000	SPHWHAHDND27YZV2D1		1423 ~		
		SPHWHAHDND27YZV3D1		V3	DI	1420 ~
90		SPHWHAHDND27YZU2H4		U2	H4	1400 ~
30	3500	SPHWHAHDND27YZU3H4	YZ	U3	117	1400 **
		SPHWHAHDND27YZU2D1		U2	D1	1473 ~
		SPHWHAHDND27YZU3D1		U3	DI	1475 ~
		SPHWHAHDND27YZT2H4		T2	H4	1429 ~
	4000	SPHWHAHDND27YZT3H4	YZ	Т3	114	1429 ~
		SPHWHAHDND27YZT2D1		T2	D1	1505 ~
		SPHWHAHDND27YZT3D1 T3	וט	1000 ~		
	5000	SPHWHAHDND27YZR3H4 R3 H4	H4	1433 ~		
	3000	SPHWHAHDND27YZR3D1	12	R3	D1	1508 ~

b) Chromaticity Region & Coordinates ($I_F = 360 \text{ mA}, T_J = 85 \, ^{\circ}\text{C}$)





	MacAdam Ellipse (W2, W3)										
Step	CIE x	CIE y									
2-step	0.4578	0.4101	53.70	0.0054	0.0028						
3-step	0.4578	0.4101	53.70	0.0081	0.0042						

MacAdam Ellipse (V2, V3)										
Step	CIE x	CIE y								
2-step	0.4338	0.403	53.22	0.0056	0.0027					
3-step	0.4338	0.4030	53.22	0.0083	0.0041					

MacAdam Ellipse (U2, U3)										
Step										
2-step	0.4073	0.3917	54.00	0.0062	0.0028					
3-step	0.4073	0.3917	54.00	0.0093	0.0041					

MacAdam Ellipse (T2, T3)							
Step	CIE x	CIE y			b		
2-step	0.3818	0.3797	53.72	0.0063	0.0027		
3-step	0.3818	0.3797	53.72	0.0094	0.0040		

MacAdam Ellipse (R3)							
Step	CIE x	CIE y					
3-step	0.3447	0.3553	59.62	0.0082	0.0035		

MacAdam Ellipse (Q3)							
Step	CIE x	CIE y					
3-step	0.3287	0.3417	59.0950	0.0075	0.0032		

MacAdam Ellipse (P3)							
Step	CIE x	CIE y					
3-step	0.3123	0.3282	58.5700	0.0067	0.0029		

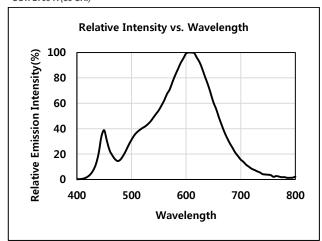
Note

Samsung maintains measurement tolerance of: Cx, $Cy = \pm 0.005$

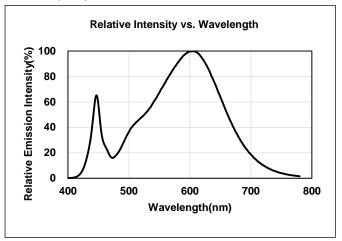
3. Typical Characteristics Graphs

a) Spectrum Distribution ($I_F = 360, T_J = 85$ °C)

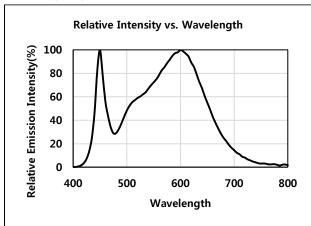
CCT: 2700 K (80 CRI)



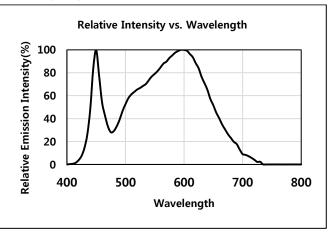
CCT: 3000 K (80 CRI)



CCT: 3500 K (80 CRI)

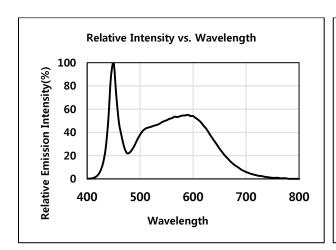


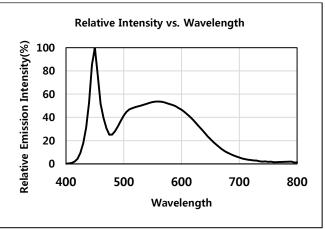
CCT: 4000 K (80 CRI)



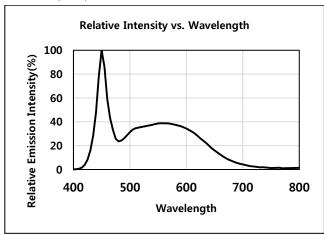
CCT: 5000 K (80 CRI)

CCT: 5700 K (80 CRI)

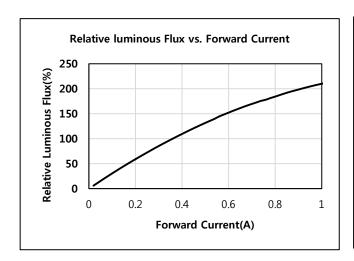


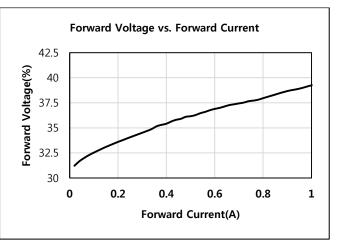




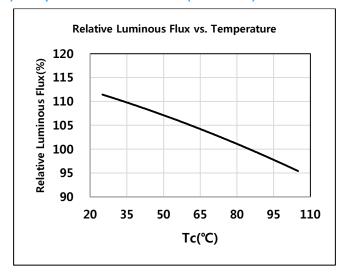


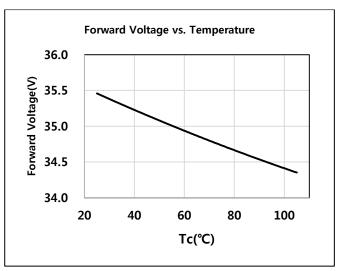
b) Forward Current Characteristics $(T_J = 85 \text{ }^{\circ}\text{C})$



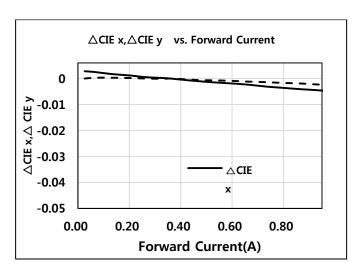


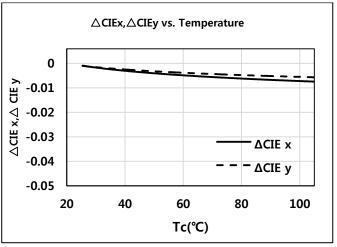
C) Temperature Characteristics (I_F = 360mA)



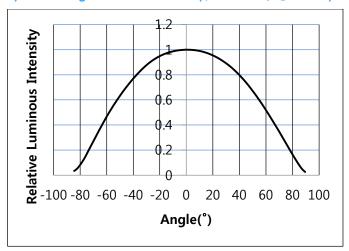


d) Color Shift Characteristics ($T_J = 25$ °C, $I_F = 360$ mA, CRI80+)

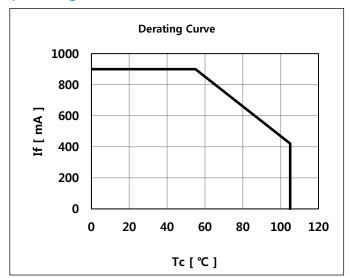




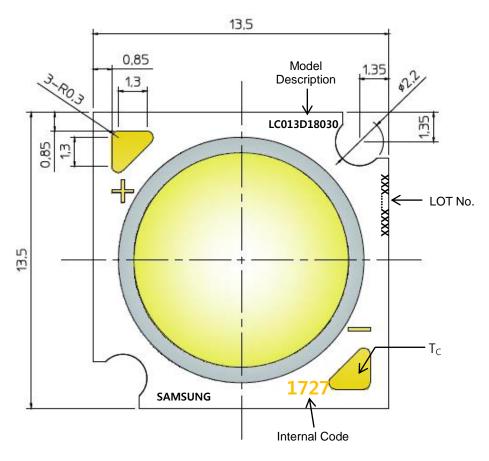
e) Beam Angle Characteristics ($I_F = 360 \text{ mA}$, $T_a = 25 \text{ }^{\circ}\text{C}$)

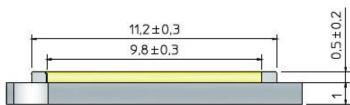


f) Derating Characteristics



4. Outline Drawing & Dimension





Unit: mm
 Tolerance: ± 0.30 mm

ltem	Dimension	Tolerance	Unit
Length	13.5	±0.15	mm
Width	13.5	±0.15	mm
Height	1.50	±0.20	mm

Light Emitting Surface (LES) Diameter	0.8	±0.30	mm
Light Emitting Surface (LES) Diameter	9.8	10.50	111111

Note: Denoted product information above is only an example

(LC013D18030 : LC013D, CRI80+, 3000K)

5. Reliability Test Items & Conditions

a) Test Items

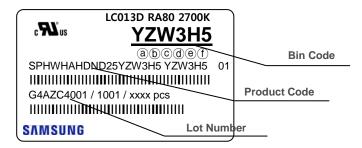
Test Item	Test Condition	Test Hour / Cycle
High Temperature Humidity Life Test	60 °C, 90 % RH,, DC Derating, I _F	1000 h
High Temperature Life Test	85 °C, DC Derating, I _F	1000 h
Low Temperature Life Test	-40 $^{\circ}$ C, DC , I _F = 700 mA	1000 h
Pulsed Operating Life Test	55 °C, Pulse width 100 μs, duty cycle 3 %	1000 h
High Temperature Storage	120 °C	1000 h
Low Temperature Storage	-40 °C	1000 h
Temperature Humidity Storage	60 °C, 90% RH	1000h
Temperature Cycle On/Off Test	-40 $^{\circ}$ C / 85 $^{\circ}$ C each 20 min, 30 min transfer power on/off each 5 min, DC Derating, $I_{\rm F}$ = max	100 cycles
ESD (HBM)	R_1 : 10 $M\Omega$ R_2 : 1.5 $k\Omega$ C : 100 pF V : ± 2 kV	5 times
ESD (MM)	R_{1} : $10~M\Omega$ R_{2} : $0~k\Omega$ C : $200~pF$ V : $\pm 0.2~kV$	5 times
Vibration Test	20 ~ 80 Hz (displacement: 0.06 inch, max. 20 g) 80 ~ 2 kHz (max. 20 g) min. frequency ↔ max. frequency 4 min transfer	4 times
Mechanical Shock Test	1500 g, 0.5 ms each of the 6 surfaces (3 axis x 2 sides)	5 times
Sulfur Resistance	25 °C, 75%, H2S 15 ppm	504h

b) Criteria for Judging the Damage

ltem	Symbol	Test Condition	Lin	nit
iteili	Зуптоот	(T _c = 25 °C)	Min.	Max.
Forward Voltage	V_{F}	I _F = 360 mA	L.S.L. * 0.9	U.S.L. * 1.1
Luminous Flux	Φ _ν	I _F = 360 mA	L.S.L* 0.7	U.S.L * 1.3

6. Label Structure

a) Label Structure



Note: Denoted bin code and product code above is only an example (see description on page 5)

Bin Code:

(a)(b): Forward Voltage bin (refer to page 11)

©d: Chromaticity bin (refer to page 9-10)

(e) f): Luminous Flux bin (refer to page 6)

b) Lot Number

The lot number is composed of the following characters:



① 3456789 / 1abc / xxxx pcs

: Production site (S: Giheung, Korea, G: Tianjin, China)

② : 4 (LED)

③ : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)

④ : Year (Z: 2015, A: 2016, B: 2017...)

(1~9, A, B, C)

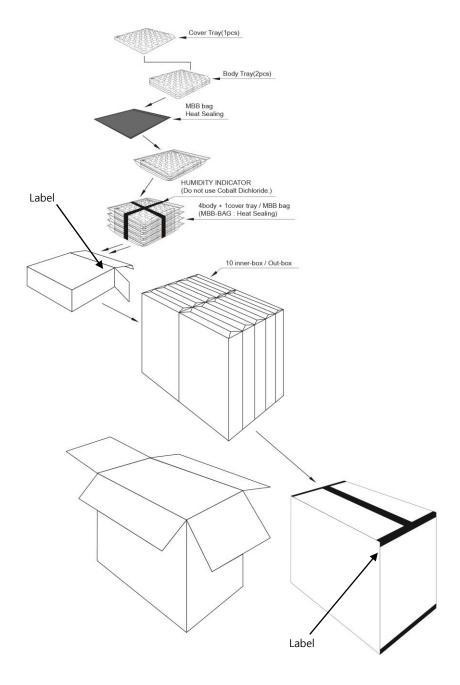
6789 : Day (1~9, A, B~V)

(a)b)C : Product serial number (001 ~ 999)

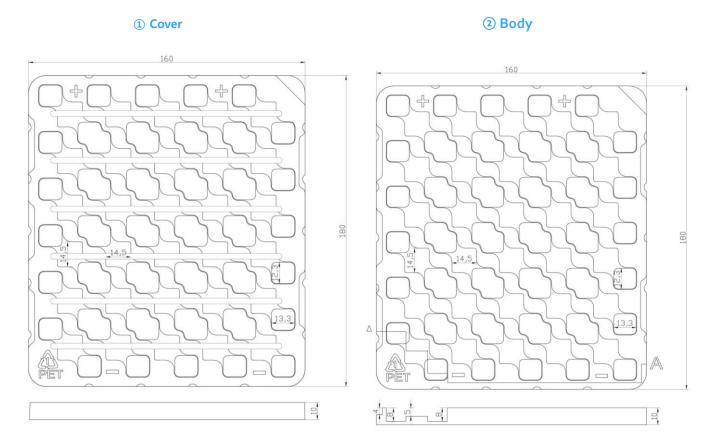
7. Packing Structure

	Max. quantity		n)		
Packing material	in pcs of COB	Length	Width	Height	Tolerance
Tray	30	160	180	10	1.0
Aluminum Bag	6o(2 trays)	210	241		10
Inner Box	240	230	84	260	2
Outer Box	2400	476	445	272	5

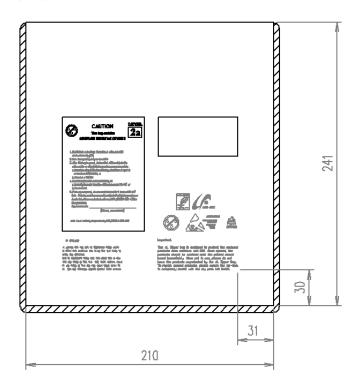
a) Packing Structure



b) Tray

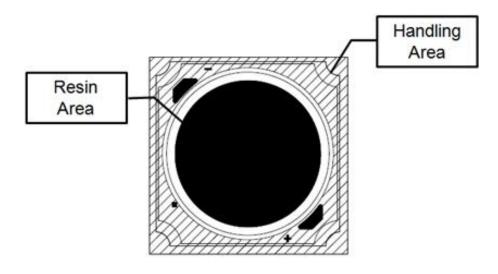


c) Aluminum Vinyl Packing Bag



8. Precautions in Handling & Use

- This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA
 is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the
 device.
- 2) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 3) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
 - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
 - b. Stored at <10 % RH
- 4) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
- 5) Devices require baking before mounting, if humidity card reading is >60 % at 23 \pm 5 °C.
- 6) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 7) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 8) The thermal management is one of the most critical factors for the LED lighting system. Especially the LED junction temperature should not exceed the absolute maximum rating while operation of LED lighting system.
 - For more information, please refer to Application Note 'Mechanical & Thermal Guide for COB'.
- 9) In case of driving LEDs around the minimum current level (If_min), chips might exhibit different brightness due to the variation in I-V characteristics of each one. This is normal and does not adversely affect the performance of product.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
- 11) The resin area is very sensitive, please do not handle, press, touch, rub, clean, or pick by with tweezers on it. Instead, please pick at the handling area as indicated below.



Legal and additional information.

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